

Title (en)

Pouring spout array and process for forming same

Title (de)

Gruppe von Ausgiesstüllen sowie Verfahren zur deren Herstellung

Title (fr)

Ensemble de becs verseurs et son procédé de fabrication

Publication

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Application

EP 00125515 A 19960719

Priority

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- JP 20781995 A 19950721

Abstract (en)

[origin: WO9703884A1] A parts supplying apparatus for supplying an array of resin molded parts (10) includes an elongated guide member (80) having a longitudinally extending guide passage (81) through which the parts array is fed, and a rotatably driven winding device (43). The guide member has a guide surface (83) along which the parts array is guided and is also provided with at least one hole (85) through which the carrier (31, 33) is drawn to allow the carrier to be drawn away and separated from the molded parts. The carrier is adapted to be wound on the winding device for pulling the carrier and effecting movement of the parts array within the guide passage and for causing the carrier to be separated from the molded parts as the molded parts move past the hole in the guide member. A parts array utilized in conjunction with such an apparatus includes a plurality of molded parts and a carrier to which each of the molded parts are arranged in a row on the carrier. The molded parts are attached to the carrier in such a way that the molded parts are separable from the carrier when the carrier is pulled away from the molded parts. The carrier can be in the form of a pair of wires (31, 33) or a tape (131).

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